

## CONTROLLED AVALANCHE RECTIFIER DIODES



Double-diffused glass passivated rectifier diodes in hermetically sealed axial-leaded glass envelopes, capable of absorbing reverse transients.

They are intended for rectifier applications as well as general purpose applications in television and communication equipment.

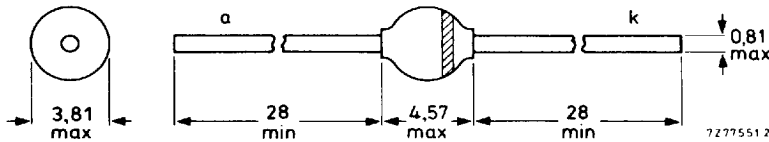
### QUICK REFERENCE DATA

		1N5059	5060	5061	5062	
Crest working reverse voltage	$V_{RWM}$ max.	200	400	600	800	V
Reverse avalanche breakdown voltage	$V_{(BR)R} >$	225	450	650	900	V
	$V_{(BR)R} <$	1600	1600	1600	1600	V
Average forward current	$I_{F(AV)}$ max.		2,0			A
Non-repetitive peak forward current	$I_{FSM}$ max.		50			A
Non-repetitive peak reverse power dissipation	$P_{RSM}$ max.		1			kW
Junction temperature	$T_j$ max.		175			°C

### MECHANICAL DATA

Dimensions in mm

Fig. 1 SOD-57.



The marking band indicates the cathode.

Products approved to CECC 50 008-015.

August 1984

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**RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

			1N5059	5060	5061	5062	
Crest working reverse voltage	$V_{RWM}$	max.	200	400	600	800	V
Continuous reverse voltage	$V_R$	max.	200	400	600	800	V
Average forward current (averaged over any 20 ms period)							
$T_{tp} = 35\text{ }^\circ\text{C}$ ; lead length 10 mm	$I_{F(AV)}$	max.		2,0			A
$T_{amb} = 75\text{ }^\circ\text{C}$ ; Fig. 2	$I_{F(AV)}$	max.		0,8			A
Repetitive peak forward current	$I_{FRM}$	max.		12			A
Non-repetitive peak forward current $t = 10\text{ ms}$ ; half sine-wave; see Figs 7 and 10	$I_{FSM}$	max.		50			A
Non-repetitive peak reverse power dissipation $t = 20\text{ }\mu\text{s}$ (half sine-wave)							
$T_j = T_{j\text{ max}}$ prior to surge	$P_{RSM}$	max.		1			kW
$t = 100\text{ }\mu\text{s}$ (half sine-wave)	$P_{RSM}$	max.		450			W
$T_j = T_{j\text{ max}}$ prior to surge							
Storage temperature	$T_{stg}$		-65 to + 175				$^\circ\text{C}$
Junction temperature	$T_j$	max.		175			$^\circ\text{C}$

**THERMAL RESISTANCE**

**Influence of mounting method**

1. Thermal resistance from junction to tie-point at a lead length of 10 mm  
 $R_{th\ j-tp} = 46\text{ K/W}$
2. Thermal resistance from junction to ambient when mounted on a 1,5 mm thick epoxy-glass printed-circuit board; Cu-thickness  $\geq 40\text{ }\mu\text{m}$ ; Fig. 2 (see "Thermal model")  
 $R_{th\ j-a} = 100\text{ K/W}$

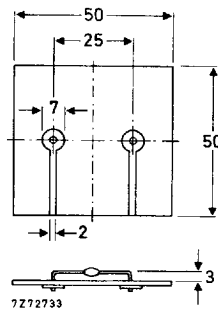


Fig. 2 Device mounted on a printed circuit board.

CHARACTERISTICS

Forward voltage;  $T_j = 25\text{ }^\circ\text{C}$  \*

$I_F = 1\text{ A}$

$I_F = 2,5\text{ A}$

$V_F <$  1 1 1 1 V

$V_F <$  1,15 1,15 1,15 1,15 V

Reverse avalanche breakdown voltage

$I_R = 0,1\text{ mA}; T_j = 25\text{ }^\circ\text{C}$

$V_{(BR)R} >$  225 450 650 900 V

$V_{(BR)R} <$  1600 1600 1600 1600 V

Reverse current

$V_R = V_{RWMmax}; T_j = 25\text{ }^\circ\text{C} **$

$V_R = V_{RWMmax}; T_j = 100\text{ }^\circ\text{C}$

$V_R = V_{RWMmax}; T_j = 165\text{ }^\circ\text{C}$

$I_R <$  1,0 1,0 1,0 1,0  $\mu\text{A}$

$I_R <$  10 10 10 10  $\mu\text{A}$

$I_R <$  150 150 150 150  $\mu\text{A}$

Reverse recovery time when switched

from  $I_F = 0,5\text{ A}$  to  $I_R = 1\text{ A}$

at  $i_{rr} = 0,25\text{ A}$

$t_{rr} <$  6  $\mu\text{s}$

$t_{rr}$  typ. 3  $\mu\text{s}$

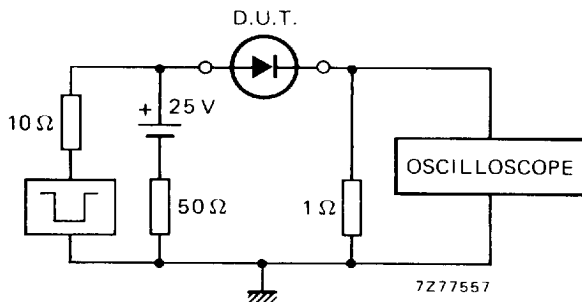


Fig. 3 Test circuit.

Input impedance oscilloscope 1 M $\Omega$ ; 22 pF. Rise time  $\leq 7\text{ ns}$ .

Source impedance 50  $\Omega$ . Rise time  $\leq 15\text{ ns}$ .

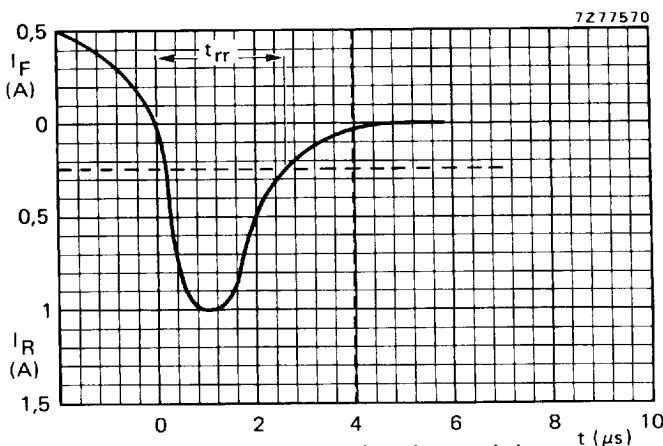


Fig. 4 Reverse recovery time characteristic.

Measured under pulse conditions to avoid excessive dissipation.

\* Illuminance  $\leq 500\text{ lux}$  (daylight); relative humidity  $< 65\%$ .

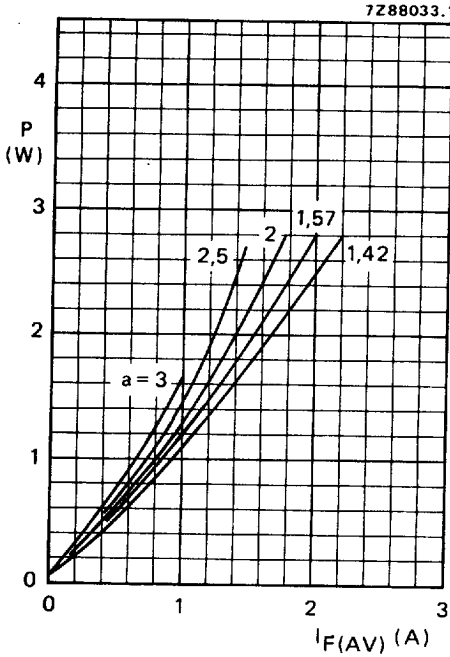


Fig. 5 Steady state power dissipation (forward plus leakage current excluding switching losses) as a function of the average forward current.

$a = I_{F(RMS)}/I_{F(AV)}$ ;  $V_R = V_{RWMmax}$ .

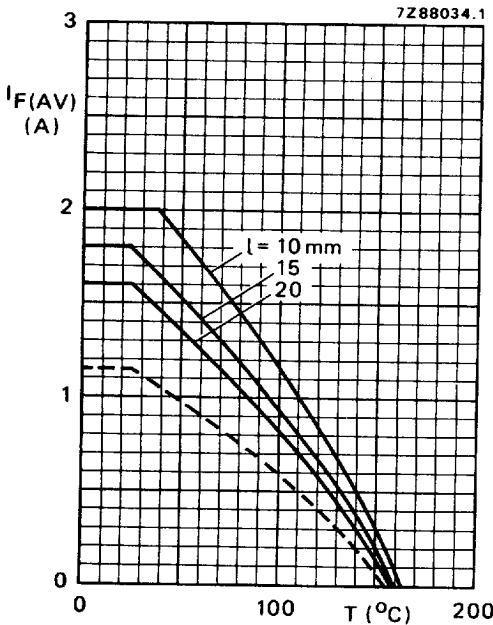


Fig. 6 Maximum average forward current as a function of the temperature. The curves include losses due to reverse current.

$a = 1,57$ ;  $V_R = V_{RWMmax}$ ;  $l$  = lead length  
 ———  $T$  = tie-point temperature  
 - - - -  $T$  = ambient temperature and device mounted as shown in Fig. 2.

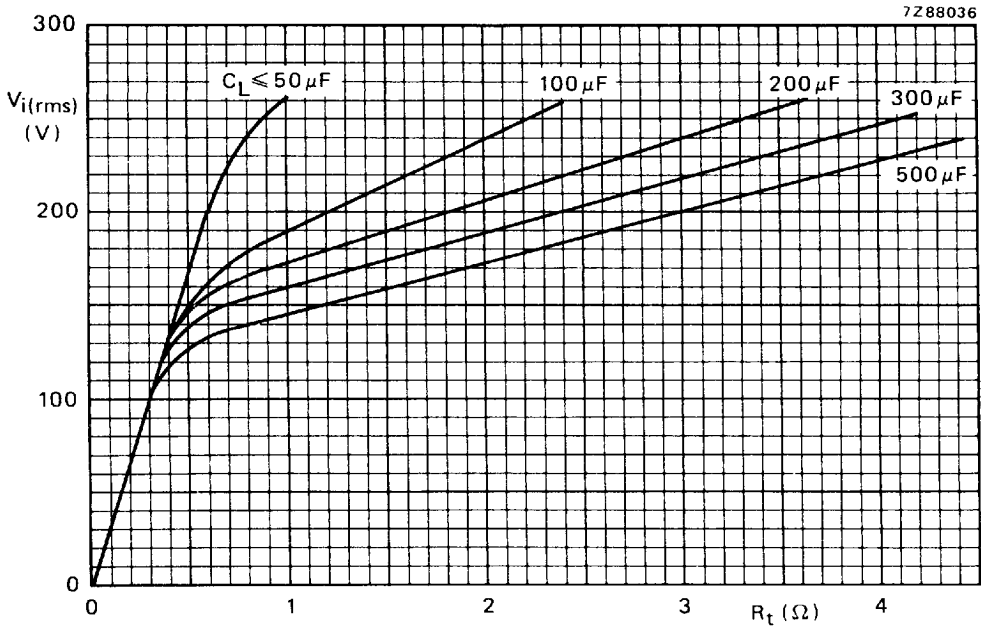


Fig. 7 Minimum values of series resistance ( $R_t$ ), including the transformer resistance, required to limit the initial peak rectifier current with capacitive load. The possibility of the following spreads are taken into account: mains voltage + 10%; capacitance + 50%, resistance - 10%.

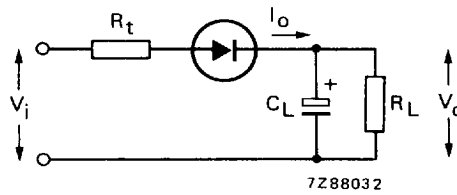


Fig. 8 Test circuit series resistance ( $R_t$ ).

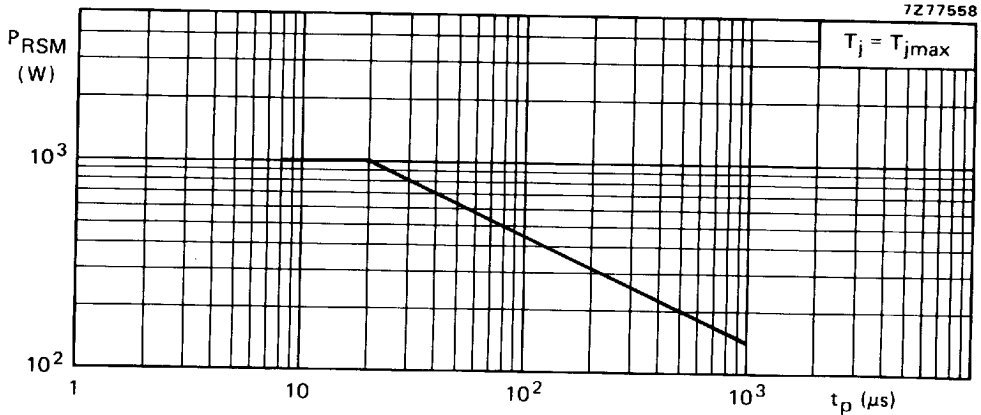


Fig. 9 Maximum permissible non-repetitive peak reverse power dissipation in the avalanche region.

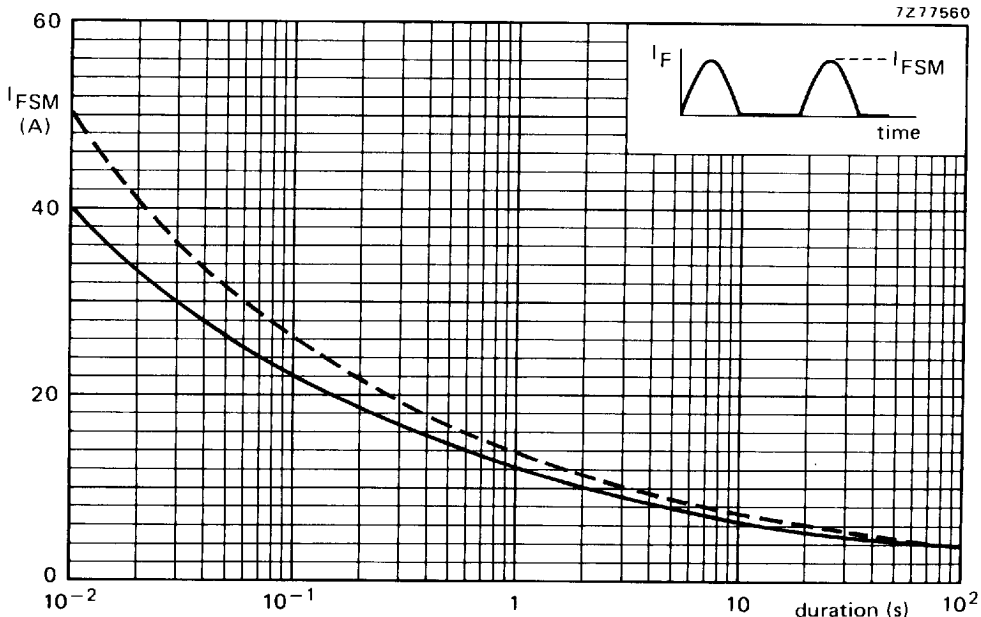
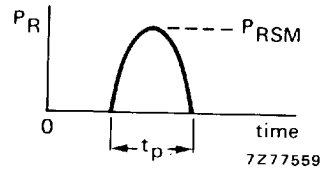


Fig. 10 Maximum permissible non-repetitive peak forward current based on sinusoidal currents ( $f = 50$  Hz).  
 ---  $T_j = 25^\circ\text{C}; V_R = 0$   
 —  $T_j = T_{jmax}$  prior to surge,  $V_R = V_{RWMmax}$ .

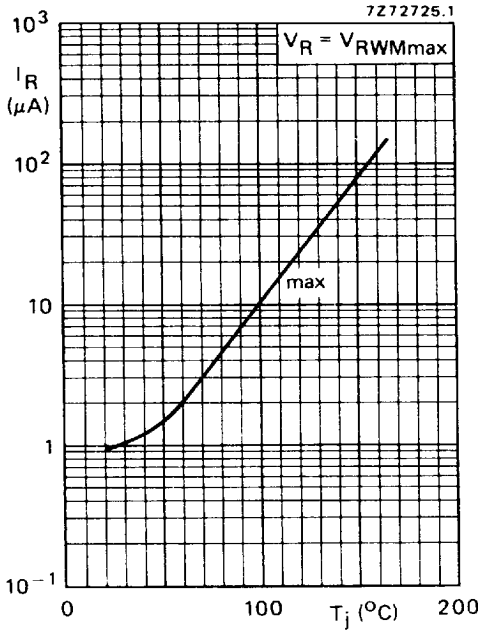


Fig. 11.

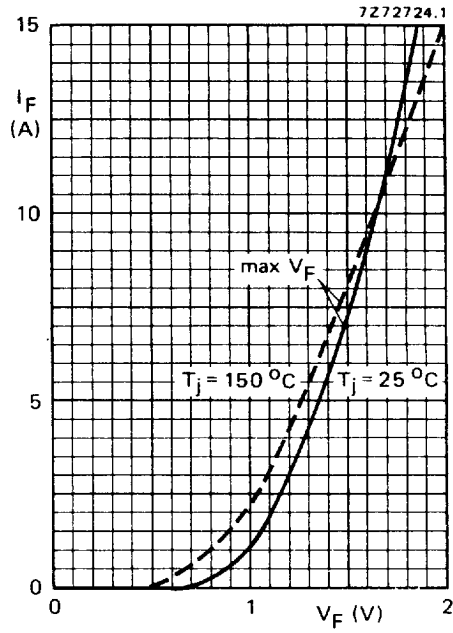


Fig. 12.

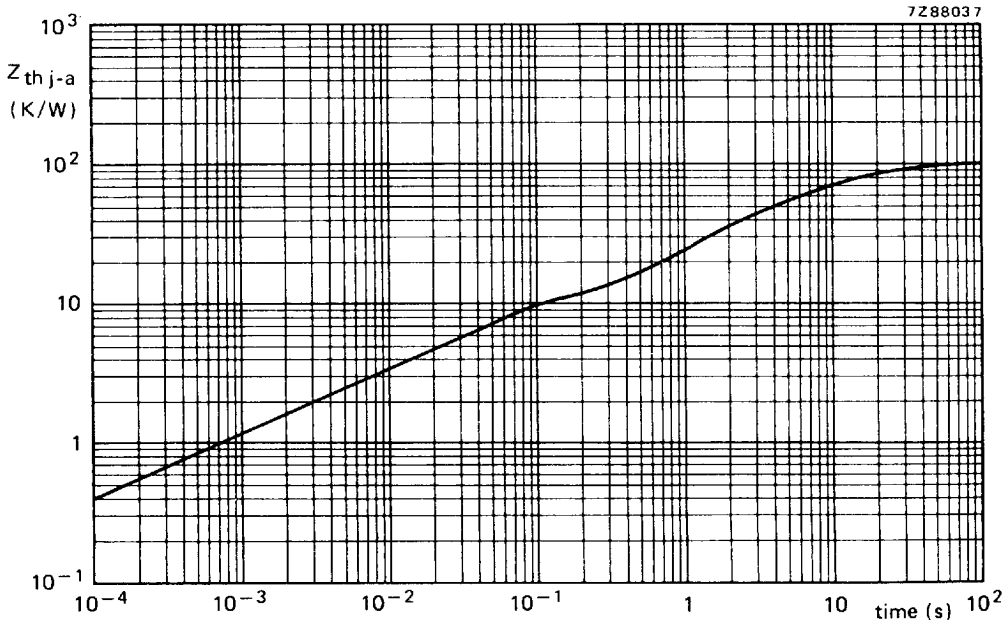


Fig. 13 Device mounted on a printed circuit board (see Fig. 2).